



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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1. Scope

The present specifications shall apply to Sanken silicon diode, FMX-2203.

2. Outline

Type	Silicon Diode	
Structure	Resin Molded	Flammability : UL94V-0(Equivalent)
Applications	High Frequency Rectification, etc.	

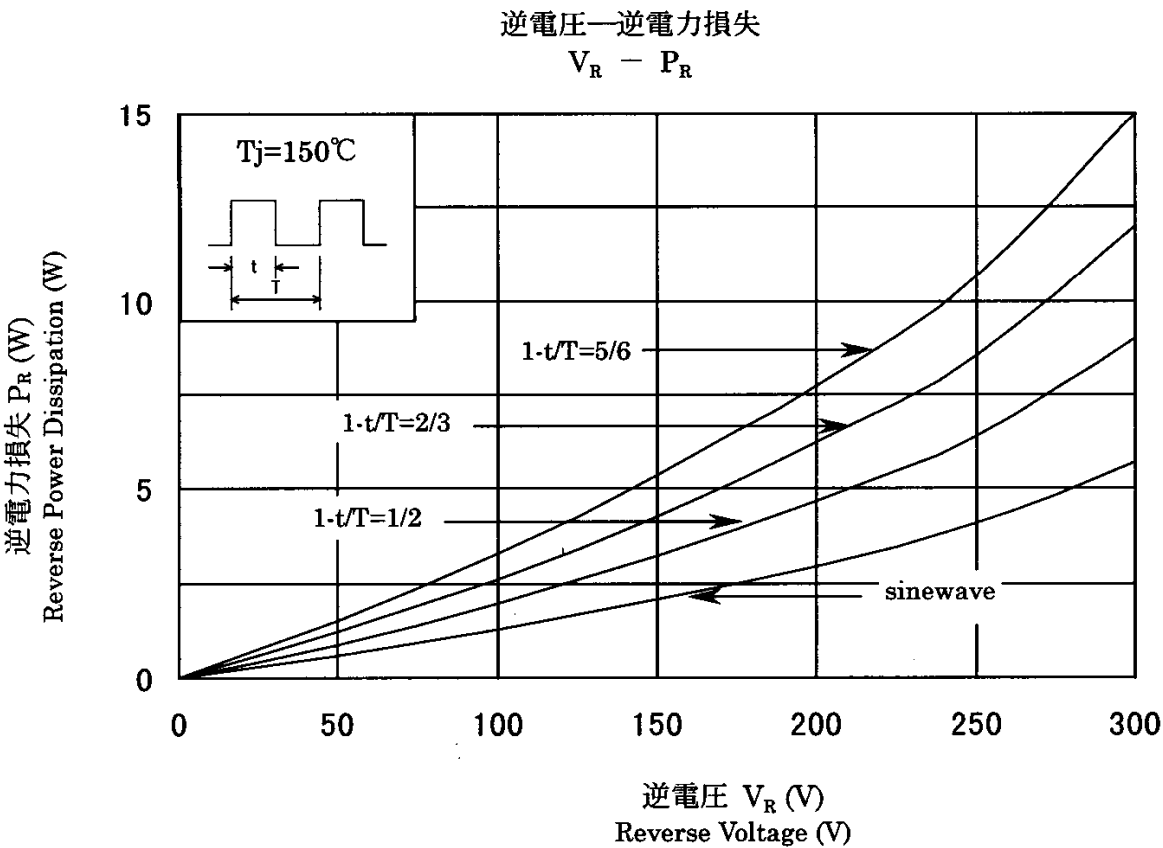
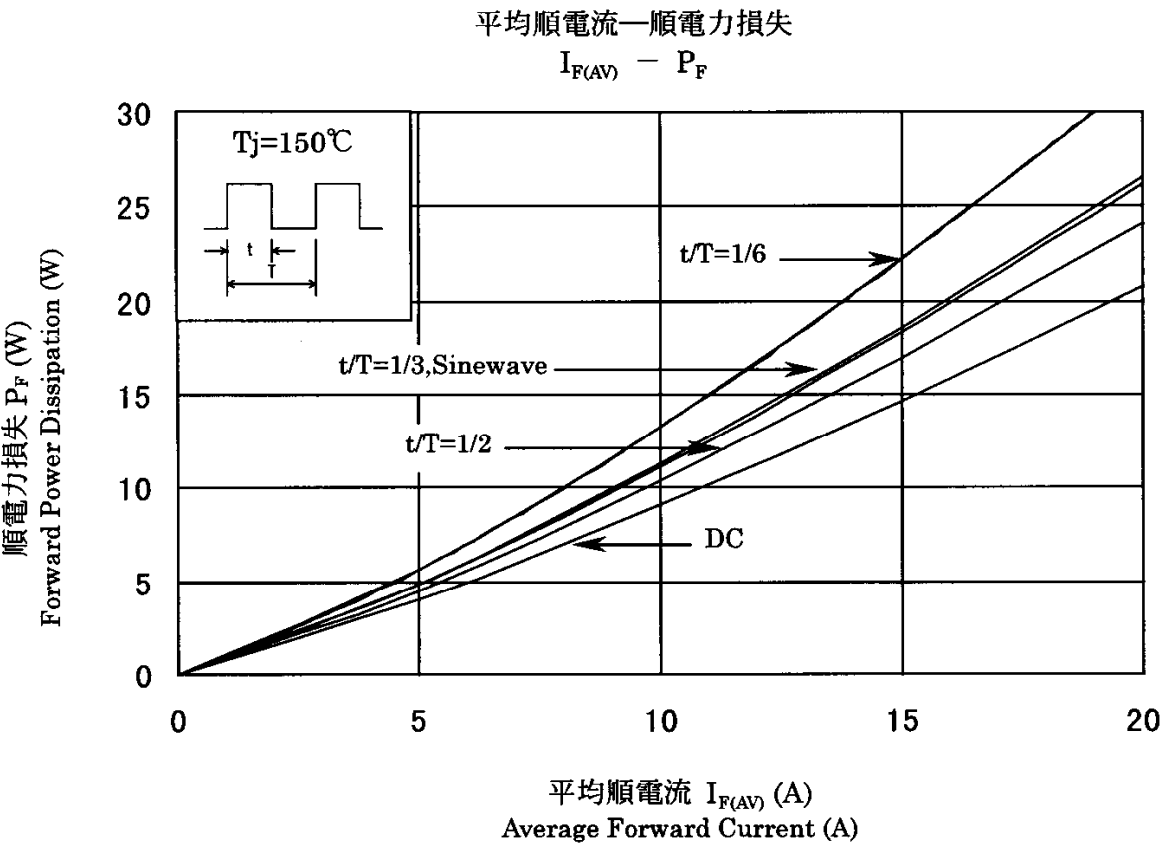
3. Absolute maximum ratings

No.	Item	Symbol	Unit	Rating	Conditions
1	Transient Peak Reverse Voltage	V_{RSM}	V	300	
2	Peak Reverse Voltage	V_{RM}	V	300	
3	Average Forward Current	$I_{F(AV)}$	A	20	Rrfer to Derating curve
4	Peak Surge Forward Current	I_{FSM}	A	100	10msec. Half sinewave, one shot
5	I^2t Limiting Value	I^2t	A^2s	50	$1ms \leq t \leq 10ms$
6	Junction Temperature	T_j	°C	- 40~+150	
7	Storage Temperature	T_{stg}	°C	- 40~+150	
8	Screwing Torque		N·m	0.59	
9	Dielectric Strength		kV	A.C. 1.0	Junction and case (1 min.)

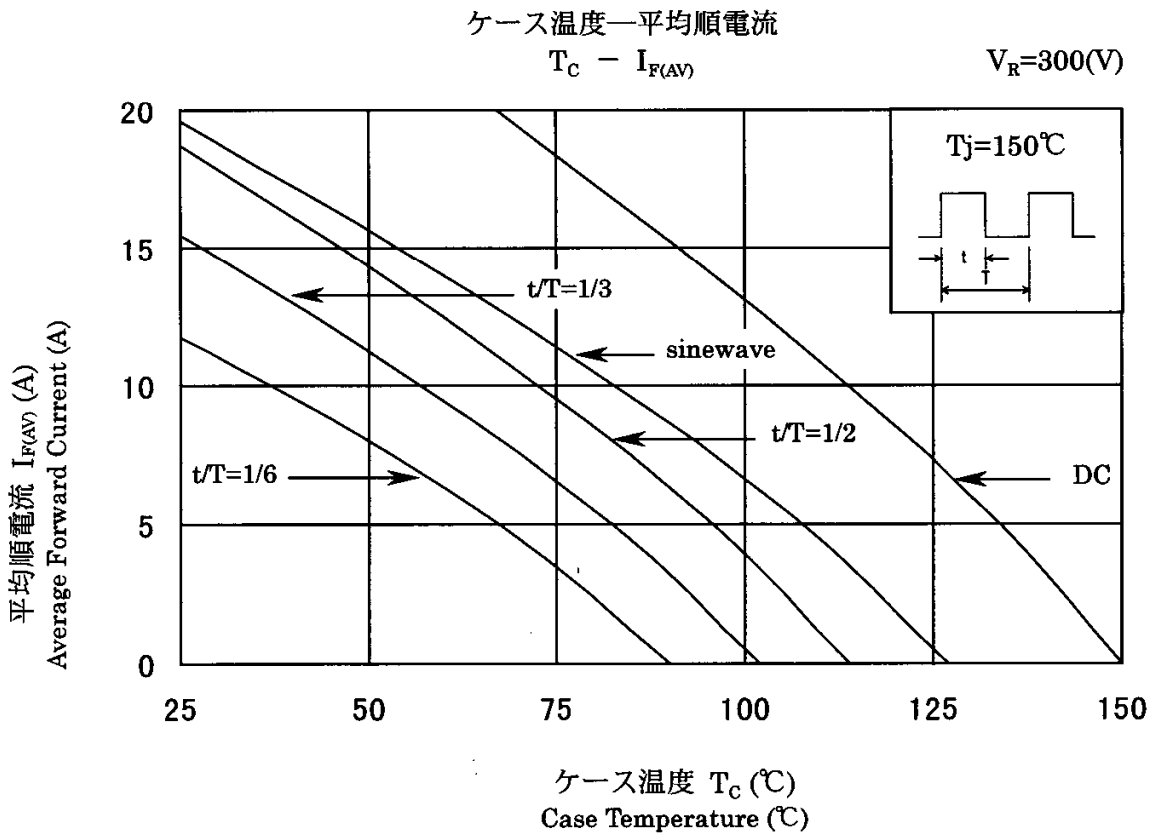
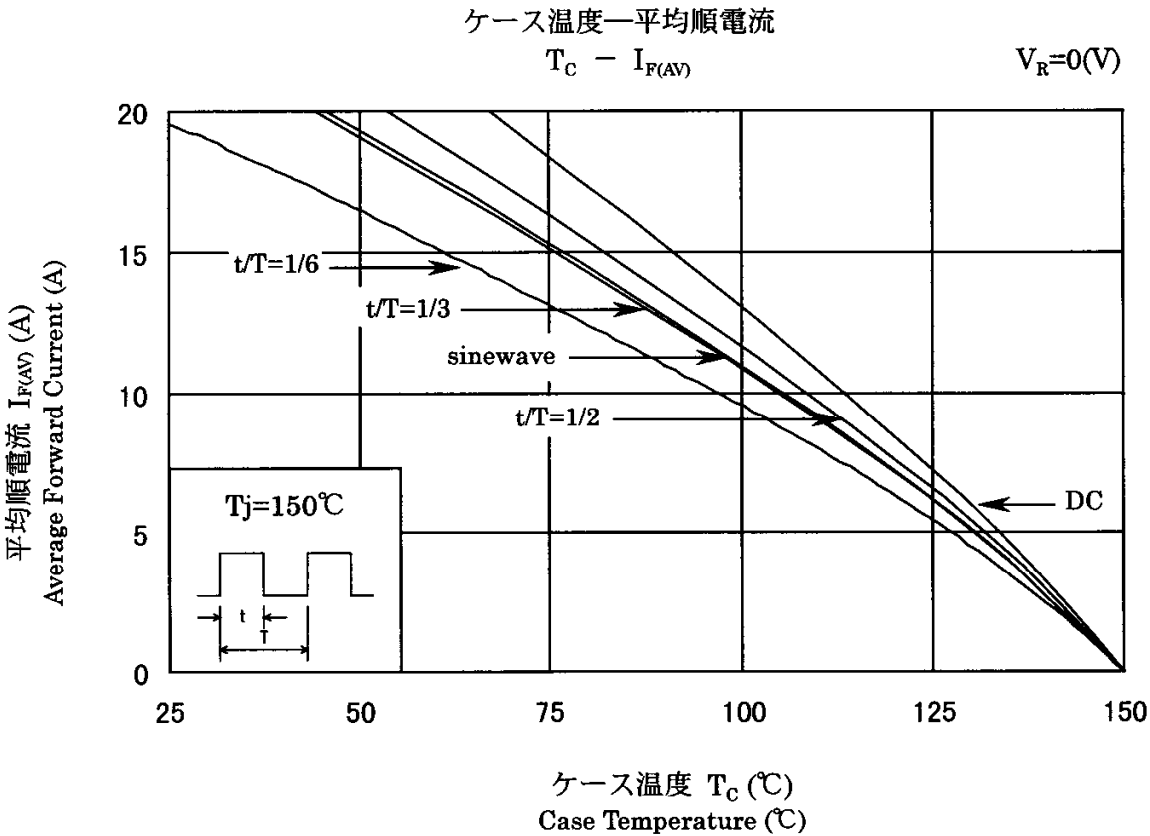
4. Electrical characteristics (Ta=25°C, unless otherwise specified)

No.	Item	Symbol	Unit	Value	Conditions
1	Forward Voltage Drop	V_F	V	1.30 max.	$I_F=10A$
2	Reverse Leakage Current	I_R	μA	100 max.	$V_R=V_{RM}$
3	Reverse Leakage Current Under High Temperature	$H \cdot I_R$	mA	30 max.	$V_R=V_{RM}$, $T_j=150^\circ C$
4	Thermal Resistance	trr1	ns	30 max.	$I_F=I_{RP}=500mA$, 90% Recovery point, $T_j=25^\circ C$
		trr2	ns	25 max.	$I_F=0.5A$, $I_{RP}=1A$, 75% Recovery point, $T_j=25^\circ C$
5	Thermal Resistance	$R_{th(j-c)}$	°C/W	4.0 max.	Between junction and case

5. Characteristics

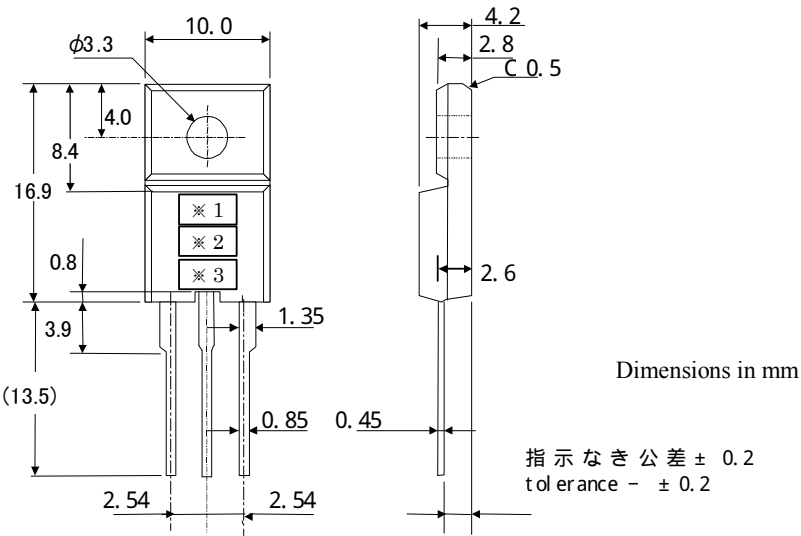


6. Derating Curve



7. Package information

7-1 Package type, physical dimensions and material



7-2 Appearance

The body shall be clean and shall not bear any stain, rust or flaw.

7-3 Marking

Type Name	Marking		
	* 1 Type Name	* 2 Polarity	* 3 Lot number
FMX-2203	X2203		1st letter: Last digit of year 2nd letter: Month From 1 to 9 for Jan. to Sep., O for Oct., N for Nov., D for Dec. 3rd & 4th letter: Day ex. 3029 (Oct. 29, 2003)